## FEATURES

- Operate From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max $\mathrm{t}_{\mathrm{pd}}$ of 7.4 ns at 3.3 V
- Typical $\mathrm{V}_{\text {olp }}$ (Output Ground Bounce) $<0.8 \mathrm{~V}$ at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
- Typical $\mathrm{V}_{\mathrm{OHV}}$ (Output $\mathrm{V}_{\mathrm{OH}}$ Undershoot) $>2 \mathrm{~V}$ at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

SN54LVC652A... JT OR W PACKAGE
SN74LVC652A... DB, DW, NS, OR PW PACKAGE (TOP VIEW)

| CLKAB [ | $1 \cup_{24}$ | $\mathrm{V}_{\mathrm{CC}}$ |
| :---: | :---: | :---: |
| SAB [ | 223 | CLKBA |
| OEAB [ | 322 | SBA |
| A1 | 421 | $\overline{O E B A}$ |
| A2 | $5 \quad 20$ | B1 |
| A3 | $6 \quad 19$ | B2 |
| A4 | $7 \quad 18$ | B3 |
| A5 | $8 \quad 17$ | B4 |
| A6 | $9 \quad 16$ | B5 |
| A7 | $10 \quad 15$ | B6 |
| A8 | $11 \quad 14$ | B7 |
| GND | $12 \quad 13$ | B8 |

- Support Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V $\mathrm{V}_{\mathrm{cc}}$ )
- $I_{\text {off }}$ Supports Partial-Power-Down Mode Operation
- ESD Protection Exceeds JESD 22
- 2000-V Human-Body Model (A114-A)
- 200-V Machine Model (A115-A)
- 1000-V Charged-Device Model (C101)

SN54LVC652A... FK PACKAGE
(TOP VIEW)


NC - No internal connection

## DESCRIPTION/ORDERING INFORMATION

The SN54LVC652A octal bus transceiver and register is designed for $2.7-\mathrm{V}$ to $3.6-\mathrm{V} \mathrm{V}_{\mathrm{CC}}$ operation, and the SN74LVC652A octal bus transceiver and register is designed for $1.65-\mathrm{V}$ to $3.6-\mathrm{V} \mathrm{V}_{\mathrm{CC}}$ operation.

ORDERING INFORMATION

| TA | PACKAGE ${ }^{(1)}$ |  | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
| :---: | :---: | :---: | :---: | :---: |
| $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | SOIC - DW | Tube of 25 | SN74LVC652ADW | LVC652A |
|  |  | Reel of 2000 | SN74LVC652ADWR |  |
|  | SOP - NS | Reel of 2000 | SN74LVC652ANSR | LVC652A |
|  | SSOP - DB | Reel of 2000 | SN74LVC652ADBR | LC652A |
|  | TSSOP - PW | Tube of 60 | SN74LVC652APW | LC652A |
|  |  | Reel of 2000 | SN74LVC652APWR |  |
|  |  | Reel of 250 | SN74LVC652APWT |  |
| $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | CDIP - JT | Tube of 15 | SNJ54LVC652AJT | SNJ54LVC652AJT |
|  | CFP - W | Tube of 85 | SNJ54LVC652AW | SNJ54LVC652AW |
|  | LCCC - FK | Tube of 42 | SNJ54LVC652AFK | SNJ54LVC652AFK |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

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## DESCRIPTION/ORDERING INFORMATION (CONTINUED)

These devices consist of bus transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the data bus or from the internal storage registers.
Output-enable (OEAB and $\overline{O E B A}$ ) inputs are provided to control the transceiver functions. Select-control (SAB and SBA) inputs are provided to select whether real-time or stored data is transferred. The circuitry used for select control eliminates the typical decoding glitch that occurs in a multiplexer during the transition between stored and real-time data. A low input selects real-time data, and a high input selects stored data. Figure 1 illustrates the four fundamental bus-management functions that are performed with the 'LVC652A devices.
Data on the A or B data bus, or both, is stored in the internal D-type flip-flops by low-to-high transitions at the appropriate clock (CLKAB or CLKBA) inputs, regardless of the select- or enable-control pins. When SAB and SBA are in the real-time transfer mode, it is possible to store data without using the internal D-type flip-flops by simultaneously enabling OEAB and OEBA. In this configuration, each output reinforces its input. When all other data sources to the two sets of bus lines are at high impedance, each set of bus lines remains at its last state.

Inputs can be driven from either $3.3-\mathrm{V}$ or $5-\mathrm{V}$ devices. This feature allows the use of these devices as translators in a mixed $3.3-\mathrm{V} / 5-\mathrm{V}$ system environment.
These devices are fully specified for partial-power-down applications using $\mathrm{I}_{\text {off. }}$. The $\mathrm{I}_{\text {off }}$ circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.
To ensure the high-impedance state during power up or power down, $\overline{O E B A}$ should be tied to $\mathrm{V}_{\mathrm{CC}}$ through a pullup resistor and OEAB should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sinking/current-sourcing capability of the driver.

FUNCTION TABLE

| INPUTS |  |  |  |  |  | DATA I/O ${ }^{(1)}$ |  | OPERATION OR FUNCTION |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OEAB | OEBA | CLKAB | CLKBA | SAB | SBA | A1-A8 | B1-B8 |  |
| L | H | H or L | H or L | X | X | Input | Input | Isolation |
| L | H | $\uparrow$ | $\uparrow$ | X | X | Input | Input | Store A and B data |
| X | H | $\uparrow$ | H or L | X | X | Input | Unspecified ${ }^{(2)}$ | Store A, hold B |
| H | H | $\uparrow$ | $\uparrow$ | $\mathrm{X}^{(2)}$ | X | Input | Output | Store A in both registers |
| L | X | H or L | $\uparrow$ | X | X | Unspecified ${ }^{(2)}$ | Input | Hold A, store B |
| L | L | $\uparrow$ | $\uparrow$ | X | $\mathrm{X}^{(2)}$ | Output | Input | Store $B$ in both registers |
| L | L | X | X | X | L | Output | Input | Real-time $B$ data to $A$ bus |
| L | L | X | H or L | X | H | Output | Input | Stored $B$ data to $A$ bus |
| H | H | X | X | L | X | Input | Output | Real-time $A$ data to $B$ bus |
| H | H | H or L | X | H | X | Input | Output | Stored $A$ data to $B$ bus |
| H | L | H or L | H or L | H | H | Output | Output | Stored A data to B bus and stored $B$ data to $A$ bus |

(1) The data-output functions can be enabled or disabled by a variety of level combinations at OEAB or OEBA. Data-input functions always are enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.
(2) Select control = L; clocks can occur simultaneously. Select control $=\mathrm{H}$; clocks must be staggered to load both registers.


Figure 1. Bus-Management Functions

LOGIC DIAGRAM (POSITIVE LOGIC)


Pin numbers shown are for the DB, DW, JT, NS, PW, and W packages.

## OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

www.ti.com

## Absolute Maximum Ratings ${ }^{(1)}$

over operating free-air temperature range (unless otherwise noted)

|  |  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage range |  | -0.5 | 6.5 | V |
| $V_{1}$ | Input voltage range |  | -0.5 | 6.5 | V |
| $\mathrm{V}_{0}$ | Voltage range applied to any output in the high-impedance or power-off state ${ }^{(2)}$ |  | -0.5 | 6.5 | V |
| $\mathrm{V}_{\mathrm{O}}$ | Voltage range applied to any output in the high or low state ${ }^{(2)(3)}$ |  | -0.5 | $\mathrm{V}_{C C}+0.5$ | V |
| $\mathrm{I}_{1}$ | Input clamp current | $\mathrm{V}_{1}<0$ |  | -50 | mA |
| l OK | Output clamp current | $\mathrm{V}_{\mathrm{O}}<0$ |  | -50 | mA |
| $\mathrm{I}_{0}$ | Continuous output current |  |  | $\pm 50$ | mA |
| Continuous current through $\mathrm{V}_{\mathrm{CC}}$ or GND |  |  |  | $\pm 100$ | mA |
| $\theta_{\mathrm{JA}}$ | Package thermal impedance ${ }^{(4)}$ | DB package |  | 63 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | DW package |  | 46 |  |
|  |  | NS package |  | 65 |  |
|  |  | PW package |  | 88 |  |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range |  | -65 | 150 | ${ }^{\circ} \mathrm{C}$ |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
(3) The value of $\mathrm{V}_{\mathrm{cc}}$ is provided in the recommended operating conditions table.
(4) The package thermal impedance is calculated in accordance with JESD 51-7.

Recommended Operating Conditions ${ }^{(1)}$

(1) All unused inputs of the device must be held at $\mathrm{V}_{\mathrm{CC}}$ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS |  | $\mathrm{V}_{\mathrm{cc}}$ | SN54LVC652A |  |  | SN74LVC652A |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP(1) |  | MAX | MIN | TYP(1) | MAX |  |
| $\mathrm{V}_{\mathrm{OH}}$ |  |  |  | $\mathrm{IOH}^{\text {a }}=-100 \mu \mathrm{~A}$ |  | 1.65 V to 3.6 V |  |  |  | $\mathrm{V}_{\text {CC }}-0.2$ |  |  | V |
|  |  | 2.7 V to 3.6 V | $\mathrm{V}_{\mathrm{CC}}-0.2$ |  |  |  |  |  |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{OH}}=-4 \mathrm{~mA}$ |  | 1.65 V |  |  |  | 1.2 |  |  |  |  |
|  |  | $\mathrm{l}_{\mathrm{OH}}=-8 \mathrm{~mA}$ |  | 2.3 V |  |  |  | 1.7 |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{OH}}=-12 \mathrm{~mA}$ |  | 2.7 V | 2.2 |  |  | 2.2 |  |  |  |  |
|  |  | 3 V | 2.4 |  |  | 2.4 |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{OH}}=-24 \mathrm{~mA}$ |  | 3 V | 2.2 |  |  | 2.2 |  |  |  |  |
| $\mathrm{V}_{\text {OL }}$ |  |  |  | $\mathrm{l}_{\mathrm{OL}}=100 \mu \mathrm{~A}$ |  | 1.65 V to 3.6 V |  |  |  |  |  | 0.2 | V |
|  |  | 2.7 V to 3.6 V | 0.2 |  |  |  |  |  |  |  |
|  |  | $\mathrm{l}_{\mathrm{OL}}=4 \mathrm{~mA}$ |  |  |  | 1.65 V |  |  |  |  |  | 0.45 |  |
|  |  | $\mathrm{l}_{\mathrm{OL}}=8 \mathrm{~mA}$ |  | 2.3 V |  |  |  |  |  | 0.7 |  |  |
|  |  | $\mathrm{I}_{\mathrm{OL}}=12 \mathrm{~mA}$ |  | 2.7 V |  |  | 0.4 |  |  | 0.4 |  |  |
|  |  | $\mathrm{l}_{\mathrm{OL}}=24 \mathrm{~mA}$ |  | 3 V |  |  | 0.55 |  |  | 0.55 |  |  |
| 1 | Control inputs | $\mathrm{V}_{1}=0$ to 5.5 V |  | 3.6 V |  |  | $\pm 5$ |  |  | $\pm 5$ | $\mu \mathrm{A}$ |  |
| $\mathrm{I}_{\text {off }}$ |  | $\mathrm{V}_{1}$ or $\mathrm{V}_{\mathrm{O}}=5.5 \mathrm{~V}$ |  | 0 |  |  |  |  |  | $\pm 10$ | $\mu \mathrm{A}$ |  |
| $\mathrm{IOz}^{(2)}$ |  | $\mathrm{V}_{\mathrm{O}}=0$ to 5.5 V |  | 3.6 V |  |  | $\pm 15$ |  |  | $\pm 10$ | $\mu \mathrm{A}$ |  |
| $I_{\text {cc }}$ |  | $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{CC}}$ or GND | $\mathrm{I}_{0}=0$ | 3.6 V |  |  | 10 |  |  | 10 | $\mu \mathrm{A}$ |  |
|  |  | $3.6 \mathrm{~V} \leq \mathrm{V}_{1} \leq 5.5 \mathrm{~V}^{(3)}$ |  |  |  |  | 10 |  |  | 10 |  |  |
| $\Delta l_{\text {CC }}$ |  | One input at $\mathrm{V}_{\mathrm{CC}}-0.6 \mathrm{~V}$, Other inputs at $V_{C C}$ or GND |  | 2.7 V to 3.6 V |  |  | 500 |  |  | 500 | $\mu \mathrm{A}$ |  |
| $\mathrm{C}_{\mathrm{i}}$ | Control inputs | $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{CC}}$ or GND |  | 3.3 V |  | 4.5 |  |  | 4.5 |  | pF |  |
| $\mathrm{C}_{\mathrm{io}}$ | A or B port | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\text {CC }}$ or GND |  | 3.3 V |  | 7.5 |  |  | 7.5 |  | pF |  |

(1) All typical values are at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(2) For I/O ports, the parameter $\mathrm{I}_{\mathrm{Oz}}$ includes the input leakage current.
(3) This applies in the disabled state only.

## Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

|  |  | SN54LVC652A |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\mathrm{cc}}=2.7 \mathrm{~V}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \\ \pm 0.3 \mathrm{~V} \end{gathered}$ |  |  |
|  |  | MIN | MAX | MIN | MAX |  |
| $\mathrm{f}_{\text {clock }}$ | Clock frequency |  | 80 |  | 100 | MHz |
| $\mathrm{t}_{\mathrm{w}}$ | Pulse duration | 3.3 |  | 3.3 |  | ns |
| $\mathrm{t}_{\text {su }}$ | Setup time, data before CLK $\uparrow$ | 1.6 |  | 1.5 |  | ns |
| $\mathrm{th}^{\text {r }}$ | Hold time, data after CLK $\uparrow$ | 0.5 |  | 1.5 |  | ns |

## Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

|  |  | SN74LVC652A |  |  |  |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\begin{gathered} \mathrm{V}_{\mathrm{cc}}=1.8 \mathrm{~V} \\ \pm 0.15 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}=2.5 \mathrm{~V} \\ \pm 0.2 \mathrm{~V} \end{gathered}$ |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{cc}}=3.3 \mathrm{~V} \\ \pm 0.3 \mathrm{~V} \end{gathered}$ |  |  |
|  |  | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX |  |
| $\mathrm{f}_{\text {clock }}$ | Clock frequency |  | (1) |  | (1) |  | 80 |  | 100 | MHz |
| $\mathrm{t}_{\mathrm{w}}$ | Pulse duration | ${ }^{(1)}$ |  | (1) |  | 3.3 |  | 3.3 |  | ns |
|  | Setup time, data before CLK $\uparrow$ | ${ }^{(1)}$ |  | ${ }^{(1)}$ |  | 1.9 |  | 1.9 |  | ns |
|  | Hold time, data after CLK $\uparrow$ | (1) |  | (1) |  | 1.5 |  | 1.7 |  | ns |

(1) This information was not available at the time of publication.

## Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM (INPUT) | $\begin{gathered} \text { TO } \\ \text { (OUTPUT) } \end{gathered}$ | SN54LVC652A |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \\ \pm 0.3 \mathrm{~V} \end{gathered}$ |  |  |
|  |  |  | MIN MAX | MIN | MAX |  |
| $\mathrm{f}_{\text {max }}$ |  |  | 80 | 100 |  | MHz |
| $\mathrm{t}_{\mathrm{pd}}$ | A or B | B or A | 7.8 | 1 | 7.4 | ns |
|  | CLK | A or B | 8.4 | 1 | 8 |  |
|  | SAB or SBA | B or A | 9.6 | 1 | 8.7 |  |
| $t_{\text {en }}$ | OEBA | A | 8.9 | 1 | 7.4 | ns |
| $\mathrm{t}_{\text {dis }}$ | $\overline{\text { OEBA }}$ | A | 8.1 | 1 | 7.5 | ns |
| $\mathrm{t}_{\text {en }}$ | OEAB | B | 8.6 | 1 | 7.1 | ns |
| $\mathrm{t}_{\text {dis }}$ | OEAB | B | 7.7 | 1 | 7.4 | ns |

## Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM (INPUT) | $\begin{gathered} \text { TO } \\ \text { (OUTPUT) } \end{gathered}$ | SN74LVC652A |  |  |  |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} \mathrm{V}_{\mathrm{cc}}=1.8 \mathrm{~V} \\ \pm 0.15 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{cc}}=2.5 \mathrm{~V} \\ \pm 0.2 \mathrm{~V} \end{gathered}$ |  | $\mathrm{V}_{\mathrm{cc}}=2.7 \mathrm{~V}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{cc}}=3.3 \mathrm{~V} \\ \pm 0.3 \mathrm{~V} \end{gathered}$ |  |  |
|  |  |  | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX |  |
| $\mathrm{f}_{\text {max }}$ |  |  | (1) |  | (1) |  | 80 |  | 100 |  | MHz |
| $\mathrm{t}_{\text {pd }}$ | A or B | B or A | (1) | (1) | (1) | (1) |  | 7.8 | 1.5 | 7.4 | ns |
|  | CLK | A or B | (1) | (1) | (1) | (1) |  | 8.4 | 1.5 | 8 |  |
|  | SAB or SBA | $B$ or $A$ | (1) | (1) | (1) | (1) |  | 9.6 | 1.5 | 8.7 |  |
| $\mathrm{t}_{\text {en }}$ | $\overline{\text { OEBA }}$ | A | (1) | (1) | (1) | (1) |  | 8.9 | 1.5 | 7.4 | ns |
| $\mathrm{t}_{\text {dis }}$ | OEBA | A | (1) | (1) | (1) | (1) |  | 8.1 | 1.5 | 7.5 | ns |
| $\mathrm{t}_{\text {en }}$ | OEAB | B | (1) | (1) | (1) | (1) |  | 8.6 | 1.5 | 7.1 | ns |
| $\mathrm{t}_{\text {dis }}$ | OEAB | B | ${ }^{(1)}$ | (1) | ${ }^{(1)}$ | (1) |  | 7.7 | 1.5 | 7.4 | ns |

(1) This information was not available at the time of publication.

SN54LVC652A, SN74LVC652A
OCTAL BUS TRANSCEIVERS AND REGISTERS

WITH 3-STATE OUTPUTS
INSTRUMENTS
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## Operating Characteristics

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| PARAMETER |  |  | TEST CONDITIONS | $\mathrm{V}_{\mathrm{CC}}=1.8 \mathrm{~V}$ | $\mathrm{V}_{\mathrm{CC}}=2.5 \mathrm{~V}$ | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | TYP | TYP | TYP |  |
| $\mathrm{C}_{\mathrm{pd}}$ | Power dissipation capacitance per transceiver | Outputs enabled |  | $\mathrm{f}=10 \mathrm{MHz}$ | (1) | (1) | 84 | pF |
|  |  | Outputs disabled | (1) |  | (1) | 9.5 |  |  |

(1) This information was not available at the time of publication.

## PARAMETER MEASUREMENT INFORMATION




VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS


Voltage waveforms SETUP AND HOLD TIMES


[^0]NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega$.
D. The outputs are measured one at a time, with one transition per measurement.
E. $t_{P L Z}$ and $t_{P H Z}$ are the same as $\mathrm{t}_{\text {dis }}$.
F. tpzL and tPZH are the same as ten.
G. $t_{P L H}$ and $t_{P H L}$ are the same as $t_{\text {pd }}$.
H. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms

INSTRUMENTS

## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead finish/ Ball material (6) | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74LVC652ADW | ACTIVE | SOIC | DW | 24 | 25 | RoHS \& Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LVC652A | Samples |
| SN74LVC652ADWR | ACTIVE | SOIC | DW | 24 | 2000 | RoHS \& Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LVC652A | Samples |
| SN74LVC652APW | ACTIVE | TSSOP | PW | 24 | 60 | RoHS \& Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LC652A | Samples |
| SN74LVC652APWR | ACTIVE | TSSOP | PW | 24 | 2000 | RoHS \& Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LC652A | Samples |
| SN74LVC652APWT | ACtive | TSSOP | PW | 24 | 250 | RoHS \& Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LC652A | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the $<=1000$ ppm threshold requirement.
${ }^{(3)}$ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a " $\sim$ " will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
${ }^{(6)}$ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## TAPE AND REEL INFORMATION



TAPE DIMENSIONS


| A0 | Dimension designed to accommodate the component width |
| :--- | :--- |
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

Reel Width (W1)
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

*All dimensions are nominal

| Device | Package <br> Type | Package <br> Drawing | Pins | SPQ | Reel <br> Diameter <br> $(\mathbf{m m})$ | Reel <br> Width <br> W1 $(\mathbf{m m})$ | A0 <br> $(\mathbf{m m})$ | B0 <br> $(\mathbf{m m})$ | K0 <br> $(\mathbf{m m})$ | P1 <br> $(\mathbf{m m})$ | W <br> $(\mathbf{m m})$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74LVC652ADWR | SOIC | DW | 24 | 2000 | 330.0 | 24.4 | 10.75 | 15.7 | 2.7 | 12.0 | 24.0 | Q1 |
| SN74LVC652APWR | TSSOP | PW | 24 | 2000 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |
| SN74LVC652APWT | TSSOP | PW | 24 | 250 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74LVC652ADWR | SOIC | DW | 24 | 2000 | 350.0 | 350.0 | 43.0 |
| SN74LVC652APWR | TSSOP | PW | 24 | 2000 | 356.0 | 356.0 | 35.0 |
| SN74LVC652APWT | TSSOP | PW | 24 | 250 | 356.0 | 356.0 | 35.0 |

## TUBE


— B - Alignment groove width
*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | $\mathbf{W}(\mathbf{m m})$ | T $(\boldsymbol{\mu m})$ | $\mathbf{B}(\mathbf{m m})$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74LVC652ADW | DW | SOIC | 24 | 25 | 506.98 | 12.7 | 4826 | 6.6 |
| SN74LVC652APW | PW | TSSOP | 24 | 60 | 530 | 10.2 | 3600 | 3.5 |

DW (R-PDSO-G24) PLASTIC SMALL OUTLINE


NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed $0.006(0,15)$.
D. Falls within JEDEC MS-013 variation AD.

DW (R-PDSO-G24)

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Refer to IPC7351 for alternate board design.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.


NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.


NOTES: (continued)
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site


SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL SCALE: 10X

NOTES: (continued)
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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[^0]:    VOLTAGE WAVEFORMS
    ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

